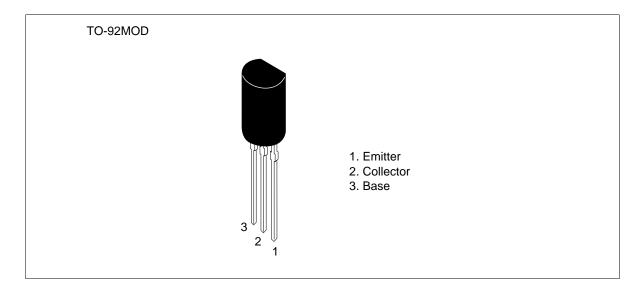
Silicon PNP Epitaxial

# **HITACHI**

#### **Application**

- Low frequency high voltage amplifier
- Complementary pair with 2SD755, 2SD756 and 2SD756A

#### **Outline**





## **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

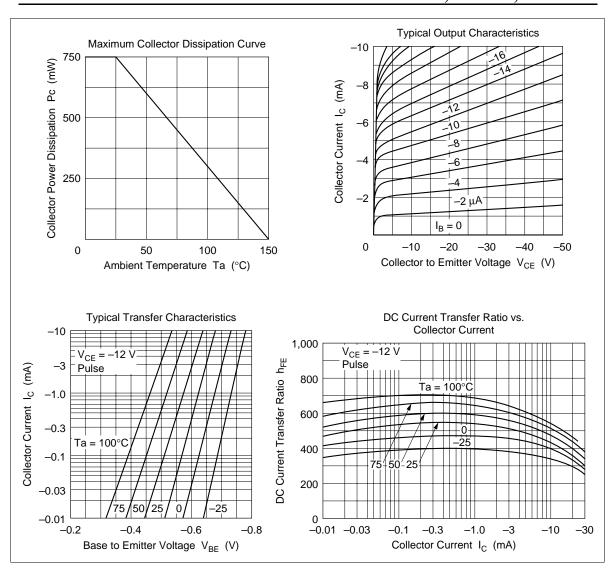
Item	Symbol	2SB715	2SB716	2SB716A	Unit
Collector to base voltage	$V_{CBO}$	-100	-120	-140	V
Collector to emitter voltage	V <sub>CEO</sub>	-100	-120	-140	V
Emitter to base voltage	$V_{EBO}$	<b>-</b> 5	<b>-</b> 5	<b>-</b> 5	V
Collector current	I <sub>c</sub>	<b>-</b> 50	<b>-</b> 50	<b>-</b> 50	mA
Collector power dissipation	P <sub>c</sub>	750	750	750	mW
Junction temperature	Tj	150	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	-55 to +150	°C

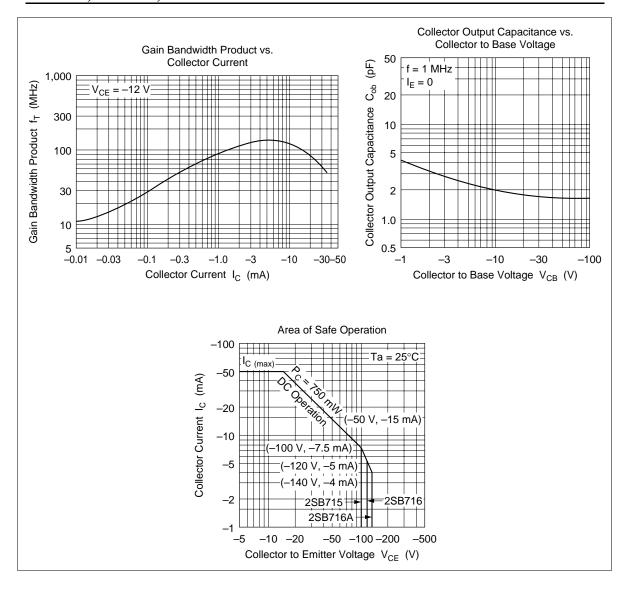
#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

		2SB7	15		2SB716		2SB716A					
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	V <sub>(BR)CBO</sub>	-100	_	_	-120	_	_	-140	_	_	V	$I_{C} = -10 \mu\text{A},  I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-100	_	_	-120	_	_	-140	_	_	V	$I_C = -1 \text{ mA},$ $R_{BE} = \infty$
Collector cutoff current	I <sub>CBO</sub>	_	_	-0.5	_	_	_	_	_	_	μΑ	$V_{CB} = -80 \text{ V}, I_{E} = 0$
			_	_	_	_	-0.5	_	_	-0.5	μΑ	$V_{CB} = -100 \text{ V}, I_{E} = 0$
DC current transfer ratio	h <sub>FE1</sub> *1	250	-	800	250	_	800	250	_	500		$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
	h <sub>FE2</sub>	125	_	_	125	_	_	125	_	_		$V_{CE} = -12 \text{ V},$ $I_{C} = -10 \text{ mA}$
Base to emitter voltage	$V_{BE}$	_	_	-0.75	_	_	-0.75	_	_	-0.75	V	$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	-0.2	_	_	-0.2	_	_	-0.2	V	$I_C = -10 \text{ mA},$ $I_B = -1 \text{ mA}$
Gain bandwidth product	f <sub>T</sub>	_	150	_	_	150	_	_	150	_	MHz	$V_{CE} = -12 \text{ V},$ $I_{C} = -5 \text{ mA}$
Collector output capacitance	Cob	_	1.8	_	_	1.8	_	_	1.8	_	pF	$V_{CB} = -25 \text{ V}, I_{E} = 0,$ f = 1 MHz

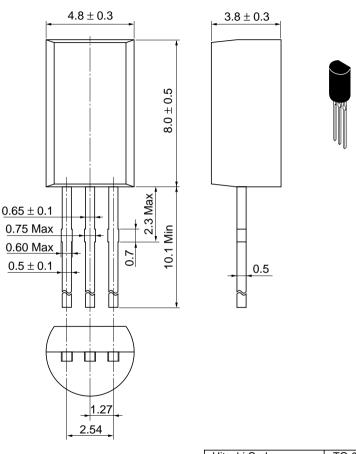
Note: 1. The 2SB715, 2SB716 and 2SB716A are grouped by h<sub>FE1</sub> as follows.

	D	E
2SB715, 2SB716	250 to 500	400 to 800
2SB716A	250 to 500	_





Unit: mm



Hitachi Code	TO-92 Mod
JEDEC	
EIAJ	Conforms
Weight (reference value)	0.35 g

#### **Cautions**

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